

International IR Rectifier

Integrated Power Hybrid IC for
Low Voltage Motor Applications

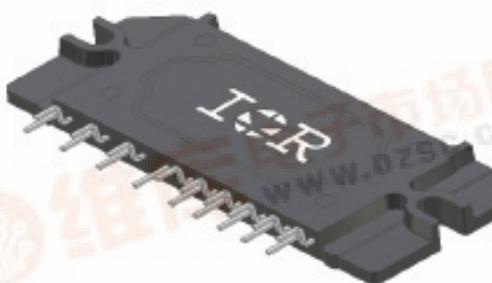
Description

International Rectifier's IRAM136-3023B is a 30A, 150V Integrated Power Hybrid IC with Internal Shunt Resistor for low voltage Motor Drives applications such as electric vehicles, portable power tools and light industrial applications. IR's technology offers an extremely compact, high performance AC motor-driver in a single isolated package to simplify design.

This advanced HIC is a combination of IR's low $R_{DS(on)}$ Advance Planar MOSFET Super Rugged technology and the industry benchmark 3-Phase high voltage, high speed driver in a fully isolated thermally enhanced package. A built-in temperature monitor and over-current and over-temperature protections and integrated under-voltage lockout function, deliver high level of protection and fail-safe operation. Using a new developed single in line package (SiP3) with heat spreader for the power die along with full transfer mold structure minimizes PCB space and resolves isolation problems to heatsink.

Features

- Integrated Gate Drivers
- Temperature Monitor and Protection
- Overcurrent shutdown
- Low $R_{DS(on)}$ Advance Planar Super Rugged Technology
- Undervoltage lockout for all channels
- Matched propagation delay for all channels
- 5V Schmitt-triggered input logic
- Cross-conduction prevention logic
- Lower di/dt gate driver for better noise immunity
- Motor Power up to 4.0kW / 48~100 Vdc
- Fully Isolated Package, Isolation 2000V_{RMS} min



Absolute Maximum Ratings

| Parameter | Description | Value | Units |
|-------------------------|---|-------------|------------------|
| $V_{BR(DSS)}$ | MOSFET Blocking Voltage | 150 | V |
| V^+ | Positive Bus Input Voltage | 100 | |
| $I_o @ T_c=25^\circ C$ | RMS Phase Current (Note 1) | 30 | A |
| $I_o @ T_c=100^\circ C$ | RMS Phase Current (Note 1) | 15 | |
| I_o | Pulsed RMS Phase Current (Note 1 and 2) | 56 | |
| F_{PWM} | PWM Carrier Frequency | 20 | kHz |
| P_D | Power Dissipation per MOSFET @ $T_c = 25^\circ C$ | 89 | W |
| V_{ISO} | Isolation Voltage (1min) | 2000 | V _{RMS} |
| T_j (MOSFET & IC) | Maximum Operating Junction Temperature | +150 | °C |
| T_c | Operating Case Temperature Range | -20 to +100 | |
| T_{STG} | Storage Temperature Range | -40 to +125 | |
| T | Mounting Torque (M4 screw) | 0.7 to 1.17 | Nm |

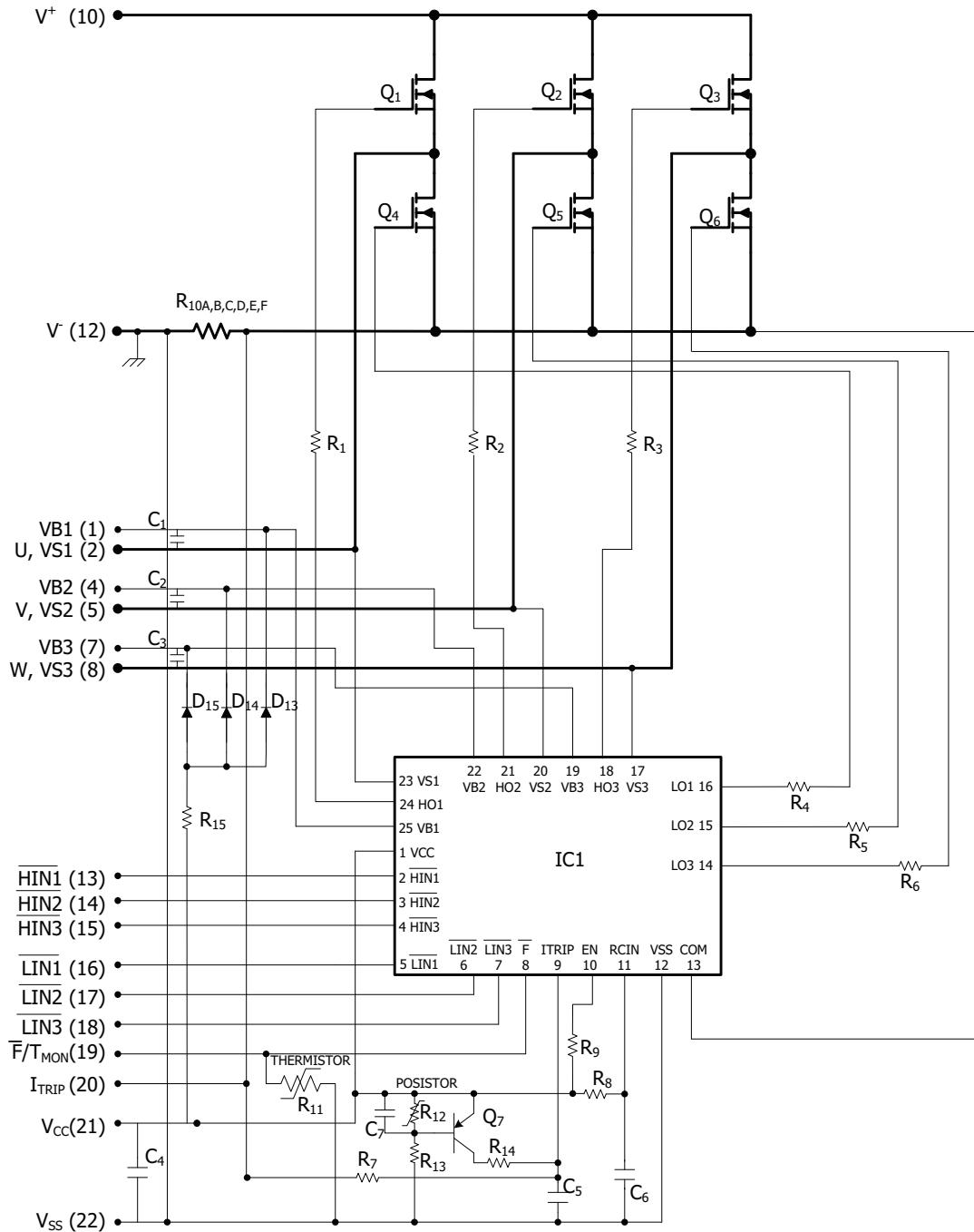
Note 1: Sinusoidal modulation at $V^+ = 100V$, $T_j = 150^\circ C$, $F_{PWM} = 20\text{kHz}$, modulation depth = 0.8, $\text{pf} = 0.6$, see Figure 3

Note 2: $t_p < 100\text{ms}$; $T_c = 25^\circ C$; $F_{PWM} = 20\text{kHz}$, limited by $I_{BUS-TRIP}$, see Table "Inverter Section Electrical Characteristics"

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Internal Electrical Schematic – IRAM136-3023B



Absolute Maximum Ratings (Continued)

| Symbol | Parameter | Min | Max | Units | Conditions |
|----------------------|--|--------------------------|--|-------|---|
| I _{BDF} | Bootstrap Diode Peak Forward Current | --- | 4.5 | A | t _p = 10ms, T _J = 150°C, T _C =100°C |
| P _{BR Peak} | Bootstrap Resistor Peak Power (Single Pulse) | --- | 25.0 | W | t _p =100μs, T _C =100°C |
| V _{S1,2,3} | High side floating supply offset voltage | V _{B1,2,3} - 25 | V _{B1,2,3} +0.3 | V | |
| V _{B1,2,3} | High side floating supply voltage | -0.3 | 150 | V | |
| V _{CC} | Low Side and logic fixed supply voltage | -0.3 | 20 | V | |
| V _{IN} | Input voltage LIN, HIN, I _{Trip} | -0.3 | Lower of (V _{SS} +15V) or V _{CC} +0.3V | V | |

Inverter Section Electrical Characteristics @T_J= 25°C

| Symbol | Parameter | Min | Typ | Max | Units | Conditions |
|-----------------------------------|---|-----|------|------|-------|--|
| V _{(BR)DSS} | Drain-to-Source Breakdown Voltage | 150 | --- | --- | V | V _{IN} =5V, I _D =250μA |
| ΔV _{(BR)DSS} / ΔT | Temperature Coeff. Of Breakdown Voltage | --- | 0.16 | --- | V/°C | V _{IN} =5V, I _D =1.0mA (25°C - 150°C) |
| R _{DS(ON)} | Drain-to-Source On Resistance | --- | 38 | 80 | mΩ | I _D =15A, V _{CC} =15V |
| | | --- | 65 | 122 | | I _D =15A, V _{CC} =15V, T _J =125°C |
| I _{DSS} | Zero Gate Voltage Drain Current | --- | 3 | 80 | μA | V _{IN} =5V, V ⁺ =150V |
| | | --- | 8 | --- | | V _{IN} =5V, V ⁺ =150V, T _J =125°C |
| V _{SD} | Body Diode Forward Voltage Drop | --- | 1.2 | 1.9 | V | I _D =15A |
| | | --- | 1.0 | 1.8 | | I _D =15A, T _J =125°C |
| V _{BDFM} | Bootstrap Diode Forward Voltage Drop | -- | -- | 1.25 | V | I _F =1A |
| | | --- | --- | 1.10 | | I _F =1A, T _J =125°C |
| R _{BR} | Bootstrap Resistor Value | --- | 22 | --- | Ω | T _J =25°C |
| ΔR _{BR} /R _{BR} | Bootstrap Resistor Tolerance | --- | --- | ±5 | % | T _J =25°C |
| I _{BUS_TRIP} | Current Protection Threshold (positive going) | 56 | --- | 68 | A | See Figure 2 |

Inverter Section Switching Characteristics @ $T_J = 25^\circ\text{C}$

| Symbol | Parameter | Min | Typ | Max | Units | Conditions |
|-----------|---|-----|-----|------|---------------|--|
| E_{ON} | Turn-On Switching Loss ^{1/} | --- | 395 | 1100 | μJ | $I_D=15\text{A}, V^+=100\text{V}$ $V_{CC}=15\text{V}, L=2\text{mH}$ Energy losses include "tail" and diode reverse recovery |
| E_{OFF} | Turn-Off Switching Loss ^{1/} | --- | 135 | 250 | | |
| E_{TOT} | Total Switching Loss ^{1/} | --- | 530 | 1350 | | |
| E_{REC} | Diode Reverse Recovery energy ^{1/} | --- | 210 | 1000 | | |
| t_{RR} | Diode Reverse Recovery time ^{1/} | --- | 240 | --- | ns | See CT1 |
| E_{ON} | Turn-on Swtiching Loss ^{1/} | --- | 360 | 970 | μJ | $I_D=15\text{A}, V^+=100\text{V}$ $V_{CC}=15\text{V}, L=2\text{mH}, T_J=125^\circ\text{C}$ Energy losses include "tail" and diode reverse recovery |
| E_{OFF} | Turn-off Switching Loss ^{1/} | --- | 115 | 210 | | |
| E_{TOT} | Total Switching Loss ^{1/} | --- | 475 | 1180 | | |
| E_{REC} | Diode Reverse Recovery energy ^{1/} | --- | 230 | 1000 | | |
| t_{RR} | Diode Reverse Recovery time ^{1/} | --- | 270 | --- | ns | See CT1 |
| Q_G | Turn-On FET Gate Charge ^{1/} | --- | 60 | 89 | nC | $I_D=36\text{A}, V^+=75\text{V}, V_{GS}=10\text{V}$ |
| E_{AS} | Single Pulse Avalanche Energy | --- | --- | 470 | mJ | Note 3, 4 |
| I_{AR} | Avalanche Current | --- | --- | 36 | A | Repetitive rating; pulse width limited by max. junction temperature. (Note 4) |
| E_{AR} | Repetitive Avalanche Energy | --- | --- | 32 | mJ | |

Note 3: Starting $T_J = 25^\circ\text{C}$, $L = 0.72\text{mH}$, $R_G = 25\Omega$, $I_{AS} = 36\text{A}$

Note 4: This is only applied to TO-220AB package

^{1/} Based on Characterization Data only. Not subject to production test.

Recommended Operating Conditions Driver Function

The Input/Output logic timing diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions. All voltages are absolute referenced to COM/ I_{TRIP} . The V_S offset is tested with all supplies biased at 15V differential (Note 5).

| Symbol | Definition | Min | Max | Units |
|--------------|--|----------|------------|-------|
| $V_{B1,2,3}$ | High side floating supply voltage | V_S+10 | V_S+20 | V |
| $V_{S1,2,3}$ | High side floating supply offset voltage | | Note 6 | |
| V_{CC} | Low side and logic fixed supply voltage | 12 | 20 | V |
| V_{IN} | Logic input voltage LIN, HIN | V_{SS} | $V_{SS}+5$ | V |

Note 5: For more details, see IR2136 data sheet

Note 6: Logic operational for V_s from COM-5V to COM+150V. Logic state held for V_s from COM-5V to COM- V_{BS} . (please refer to DT97-3 for more details)

Static Electrical Characteristics Driver Function @ $T_J = 25^\circ\text{C}$

V_{BIAS} ($V_{CC}, V_{BS1,2,3}$)=15V, unless otherwise specified. The V_{IN} and I_{IN} parameters are referenced to V_{SS} and are applicable to all six channels (Static Electrical Characteristics are Based on Driver IC Data Sheet, Note 5).

| Symbol | Definition | Min | Typ | Max | Units |
|------------------------|---|-----|-----|------|---------------|
| V_{IH} | Logic "0" input voltage | 3.0 | --- | --- | V |
| V_{IL} | Logic "1" input voltage | --- | --- | 0.8 | V |
| V_{CCUV+}, V_{BSUV+} | V_{CC} and V_{BS} supply undervoltage positive going threshold | 8.0 | 8.9 | 9.8 | V |
| V_{CCUV-}, V_{BSUV-} | V_{CC} and V_{BS} supply undervoltage negative going threshold | 7.4 | 8.2 | 9.0 | V |
| V_{CCUVH}, V_{BSUVH} | V_{CC} and V_{BS} supply undervoltage lock-out hysteresis | 0.3 | 0.7 | --- | V |
| $V_{IN,Clamp}$ | Input Clamp Voltage (HIN, LIN, T/I _{TRIP}) $I_{IN}=10\mu\text{A}$ | 4.9 | 5.2 | 5.5 | V |
| I_{QBS} | Quiescent V_{BS} supply current $V_{IN}=0\text{V}$ | --- | --- | 165 | μA |
| I_{QCC} | Quiescent V_{CC} supply current $V_{IN}=0\text{V}$ | --- | --- | 3.35 | mA |
| I_{LK} | Offset Supply Leakage Current | --- | --- | 60 | μA |
| I_{IN+} | Input bias current $V_{IN}=5\text{V}$ | --- | 200 | 300 | μA |
| I_{IN-} | Input bias current $V_{IN}=0\text{V}$ | --- | 100 | 220 | μA |
| I_{TRIP+} | I_{TRIP} bias current $V_{I_{TRIP}}=5\text{V}$ | --- | 30 | 100 | μA |
| I_{TRIP-} | I_{TRIP} bias current $V_{I_{TRIP}}=0\text{V}$ | --- | 0 | 1 | μA |
| $V(I_{TRIP})$ | I_{TRIP} threshold Voltage | 440 | 490 | 540 | mV |
| $V(I_{TRIP,HYS})$ | I_{TRIP} Input Hysteresis | --- | 70 | --- | mV |

Dynamic Electrical Characteristics @ $T_J = 25^\circ\text{C}$

| Symbol | Parameter | Min | Typ | Max | Units | Conditions |
|----------------|---|-----|------|-----|---------------|--|
| T_{ON} | Input to Output propagation turn-on delay time (see fig.11) ^{2/} | --- | 0.83 | --- | μs | $V_{CC}=V_{BS}= 15\text{V}, I_D=30\text{A}, V^+=100\text{V}$ |
| T_{OFF} | Input to Output propagation turn-off delay time (see fig. 11) ^{2/} | --- | 1.08 | --- | μs | |
| T_{FLIN} | Input Filter time (HIN, LIN) ^{3/} | 100 | 200 | --- | ns | $V_{IN}=0 \& V_{IN}=5\text{V}$ |
| $T_{BLT-Trip}$ | I_{TRIP} Blancking Time ^{3/} | 100 | 150 | --- | ns | $V_{IN}=0 \& V_{IN}=5\text{V}$ |
| D_T | Dead Time ($V_{BS}=V_{DD}=15\text{V}$) ^{3/} | 220 | 290 | 360 | ns | $V_{BS}=V_{CC}=15\text{V}$ |
| M_T | Matching Propagation Delay Time (On & Off) ^{3/} | --- | 40 | 75 | ns | $V_{CC}= V_{BS}= 15\text{V}, \text{external dead time} > 400\text{ns}$ |
| T_{ITrip} | I_{Trip} to six switch to turn-off propagation delay (see fig. 2) ^{4/} | --- | 3.2 | --- | μs | $V_{CC}=V_{BS}= 15\text{V}, I_D=30\text{A}, V^+=100\text{V}$ |
| $T_{FLT-CLR}$ | Post I_{Trip} to six switch to turn-off clear time (see fig. 2) ^{4/} | --- | 7.7 | --- | ms | $T_C = 25^\circ\text{C}$ |
| | | --- | 6.7 | --- | | $T_C = 100^\circ\text{C}$ |

^{2/} Based on Characterization Data only. Not subject to production test.

^{3/} Based on Driver IC Data Sheet.

^{4/} Verified by Design. Not subject to production test.

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Thermal and Mechanical Characteristics

| Symbol | Parameter | Min | Typ | Max | Units | Conditions |
|---------------|---------------------------------------|-----|-----|-----|-------|--|
| $R_{th(J-C)}$ | Thermal resistance, FET ^{5/} | --- | 1.2 | 1.4 | °C/W | Flat, greased surface. Heatsink compound thermal conductivity 1W/m°K |
| $R_{th(C-S)}$ | Thermal resistance, C-S ^{5/} | --- | 0.1 | --- | | |
| C_D | Creepage Distance | 3.5 | --- | --- | mm | See outline Drawings |

^{5/} Based on Characterization Data only. Not subject to production test.

Internal Current Sensing Resistor - Shunt Characteristics

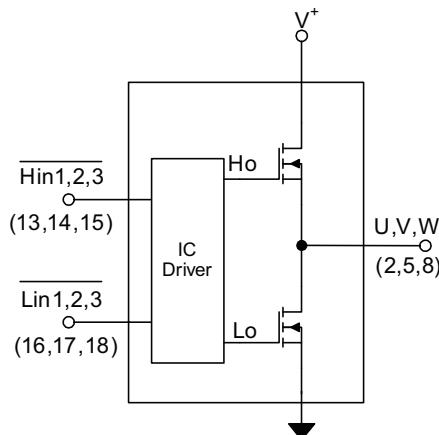
| Symbol | Parameter | Min | Typ | Max | Units | Conditions |
|-------------|-------------------------|-----|-----|-----|--------|--------------------------|
| R_{Shunt} | Resistance | 8.1 | 8.3 | 8.5 | mΩ | $T_C = 25^\circ\text{C}$ |
| T_{Coeff} | Temperature Coefficient | 0 | --- | 200 | ppm/°C | |
| P_{Shunt} | Power Dissipation | --- | --- | 4.5 | W | -40°C < T_C < 100°C |
| T_{Range} | Temperature Range | -20 | --- | 125 | °C | |

Internal NTC - Thermistor Characteristics

| Parameter | Definition | Min | Typ | Max | Units | Conditions |
|---------------------------|------------------------------------|------|------|------|-------|------------------------------------|
| R_{25} | Resistance | 97 | 100 | 103 | kΩ | $T_C = 25^\circ\text{C}$ |
| R_{125} | Resistance ^{6/} | 2.25 | 2.52 | 2.80 | kΩ | $T_C = 125^\circ\text{C}$ |
| B | B-constant (25-50°C) ^{6/} | 4165 | 4250 | 4335 | k | $R_2 = R_1 e^{[B(1/T_2 - 1/T_1)]}$ |
| Temperature Range | | -20 | --- | 125 | °C | |
| Typ. Dissipation constant | | --- | 1 | --- | mW/°C | $T_C = 25^\circ\text{C}$ |

^{6/} Verified by Design. Not subject to production test.

Input-Output Logic Level Table



| I_{TRIP} | $\overline{HIN1,2,3}$ | $\overline{LIN1,2,3}$ | U,V,W |
|------------|-----------------------|-----------------------|---------|
| 0 | 0 | 1 | V^+ |
| 0 | 1 | 0 | 0 |
| 0 | 1 | 1 | X |
| 1 | X | X | X |

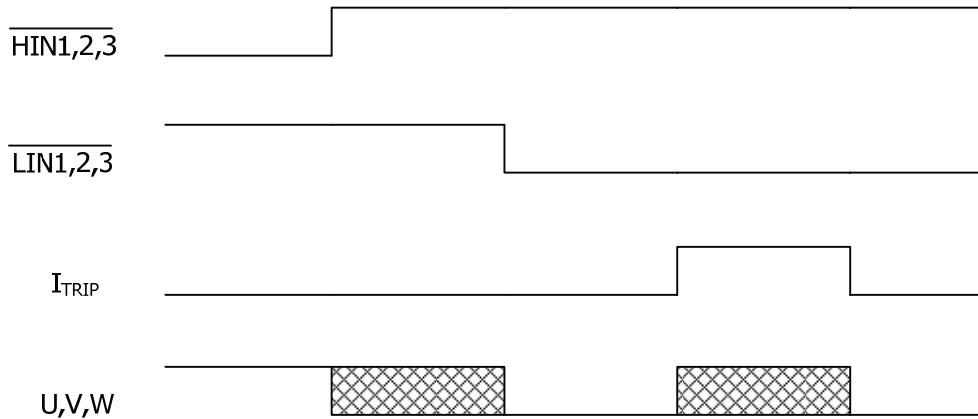


Figure 1. Input/Output Timing Diagram

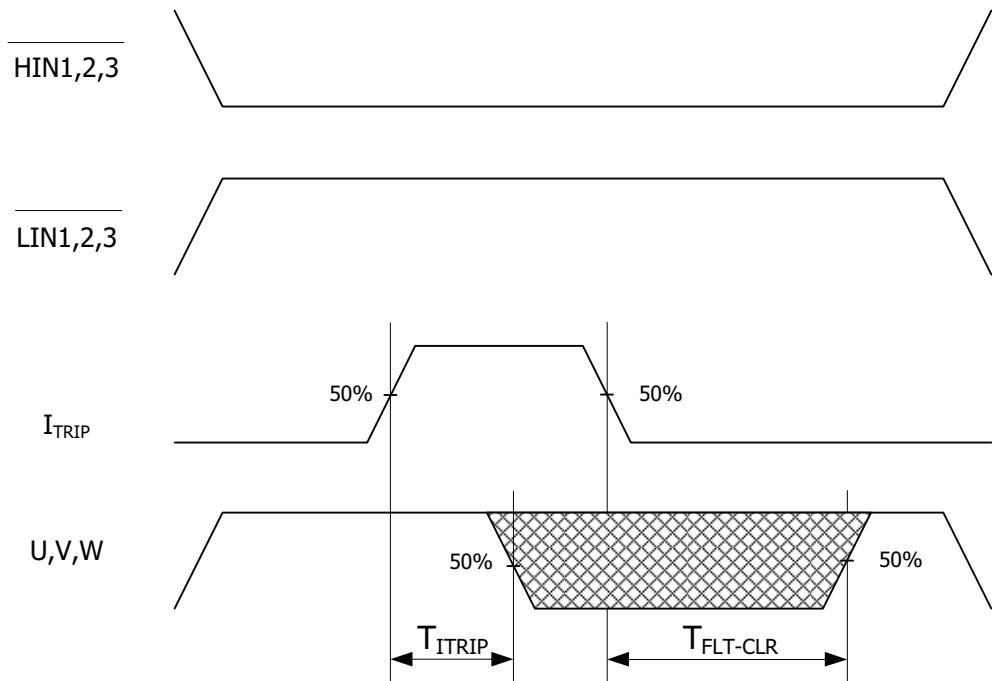


Figure 2. I_{TRIP} Timing Waveform

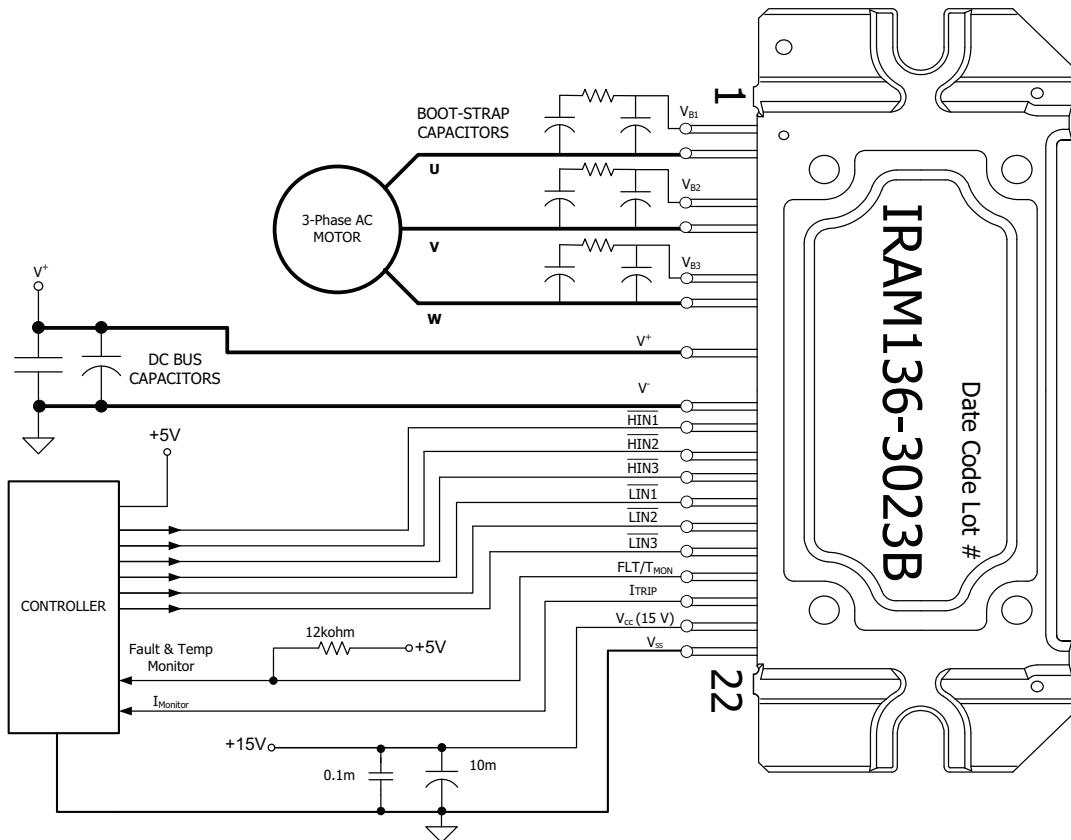
Note 7: The shaded area indicates that both high-side and low-side switches are off and therefore the half-bridge output voltage would be determined by the direction of current flow in the load.

Module Pin-Out Description

| Pin | Name | Description |
|-----|----------------------------|---|
| 1 | V_{B1} | High Side Floating Supply Voltage 1 |
| 2 | U, V_{S1} | Output 1 - High Side Floating Supply Offset Voltage |
| 3 | NA | none |
| 4 | V_{B2} | High Side Floating Supply voltage 2 |
| 5 | V, V_{S2} | Output 2 - High Side Floating Supply Offset Voltage |
| 6 | NA | none |
| 7 | V_{B3} | High Side Floating Supply voltage 3 |
| 8 | W, V_{S3} | Output 3 - High Side Floating Supply Offset Voltage |
| 9 | NA | none |
| 10 | V^+ | Positive Bus Input Voltage |
| 11 | NA | none |
| 12 | V^- | Negative Bus Input Voltage |
| 13 | \overline{H}_{IN1} | Logic Input High Side Gate Driver - Phase 1 |
| 14 | \overline{H}_{IN2} | Logic Input High Side Gate Driver - Phase 2 |
| 15 | \overline{H}_{IN3} | Logic Input High Side Gate Driver - Phase 3 |
| 16 | \overline{L}_{IN1} | Logic Input Low Side Gate Driver - Phase 1 |
| 17 | \overline{L}_{IN2} | Logic Input Low Side Gate Driver - Phase 2 |
| 18 | \overline{L}_{IN3} | Logic Input Low Side Gate Driver - Phase 3 |
| 19 | $\overline{Fault/T}_{MON}$ | Temperature Monitor and Fault Function |
| 20 | I_{Sense} | Current Monitor |
| 21 | V_{CC} | +15V Main Supply |
| 22 | V_{SS} | Negative Main Supply |



Typical Application Connection IRAM136-3023B



1. Electrolytic bus capacitors should be mounted as close to the module bus terminals as possible to reduce ringing and EMI problems. Additional high frequency ceramic capacitor mounted close to the module pins will further improve performance.
2. In order to provide good decoupling between **V_{CC}-V_{VSS}** and **V_{B1,2,3}-V_{S1,2,3}** terminals, the capacitors shown connected between these terminals should be located very close to the module pins. Additional high frequency capacitors, typically $0.1\mu F$, are strongly recommended.
3. Value of the boot-strap capacitors depends upon the switching frequency. Their selection should be made based on IR design tip DN 98-2a, application note AN-1044 or Figure 9. Bootstrap capacitor value must be selected to limit the power dissipation of the internal resistor in series with the **V_{CC}**. (see maximum ratings Table on page 3).
4. After approx. 8ms the FAULT is reset. (see Dynamic Characteristics Table on page 5).
5. PWM generator must be disabled within Fault duration to guarantee shutdown of the system, overcurrent condition must be cleared before resuming operation.
6. Fault/ T_{MON} Monitor pin must be pulled-up to **+5V**.

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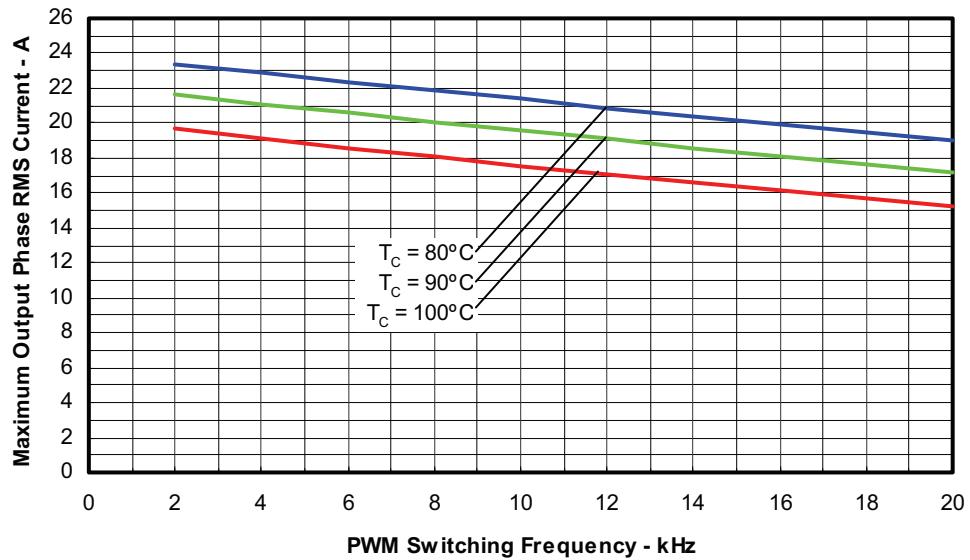


Figure 3. Maximum Sinusoidal Phase Current vs. PWM Switching Frequency
Sinusoidal Modulation, $V^+ = 100\text{V}$, $T_J = 150^\circ\text{C}$, Modulation Depth = 0.8, PF = 0.6

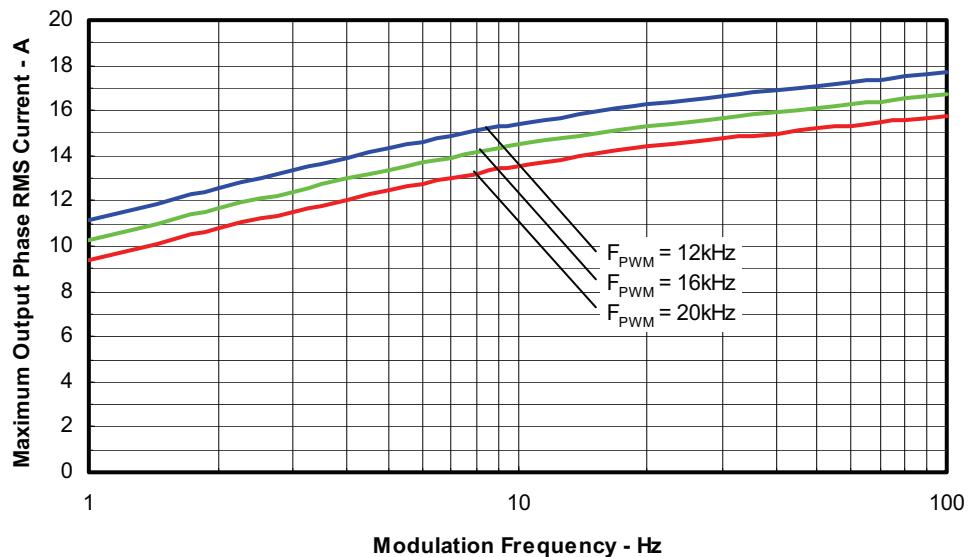


Figure 4. Maximum Sinusoidal Phase Current vs. Modulation Frequency
Sinusoidal Modulation, $V^+ = 100\text{V}$, $T_J = 100^\circ\text{C}$, Modulation Depth = 0.8, PF = 0.6

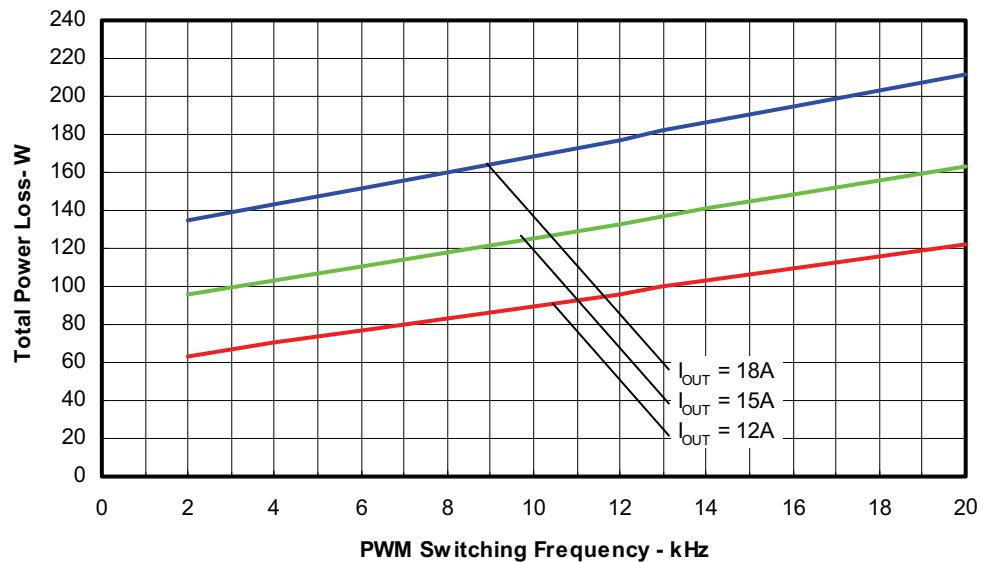


Figure 5. Total Power Losses vs. PWM Switching Frequency
 Sinusoidal Modulation, $V^+ = 100V$, $T_j = 150^\circ C$, Modulation Depth = 0.8, PF = 0.6

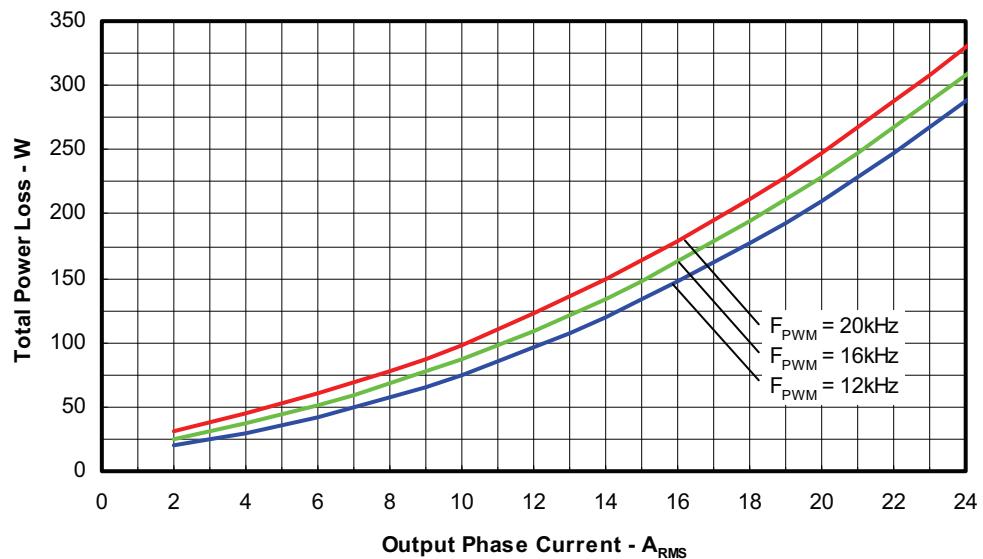


Figure 6. Total Power Losses vs. Output Phase Current
 Sinusoidal Modulation, $V^+ = 100V$, $T_j = 150^\circ C$, Modulation Depth = 0.8, PF = 0.6

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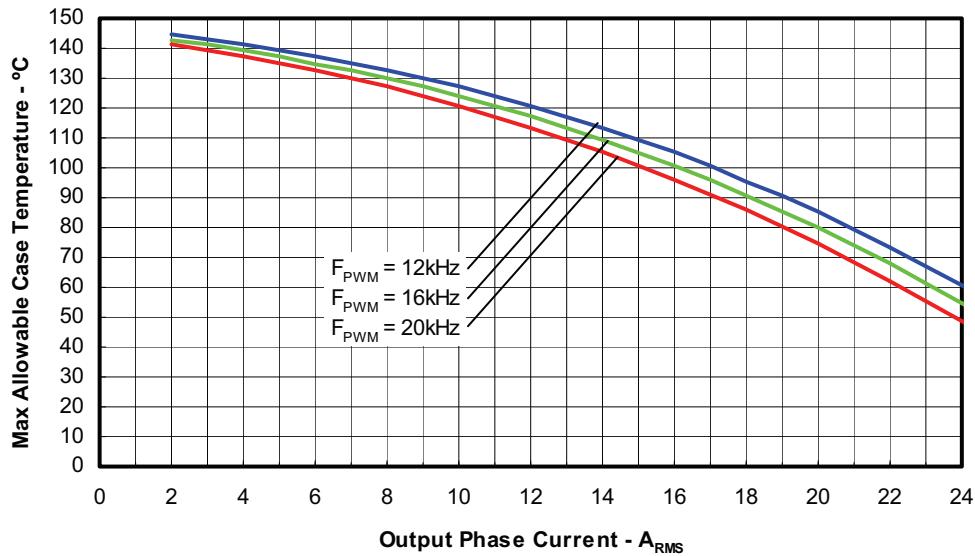


Figure 7. Maximum Allowable Case Temperature vs. Output RMS Current per Phase
Sinusoidal Modulation, V⁺=100V, T_J=150°C, Modulation Depth=0.8, PF=0.6

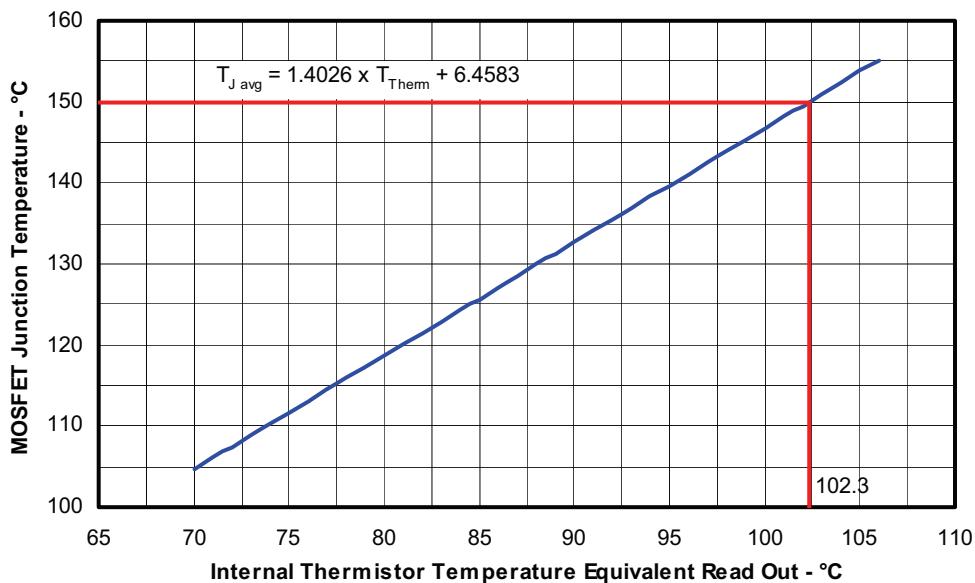


Figure 8. Estimated Maximum MOSFET Junction Temperature vs. Thermistor Temperature

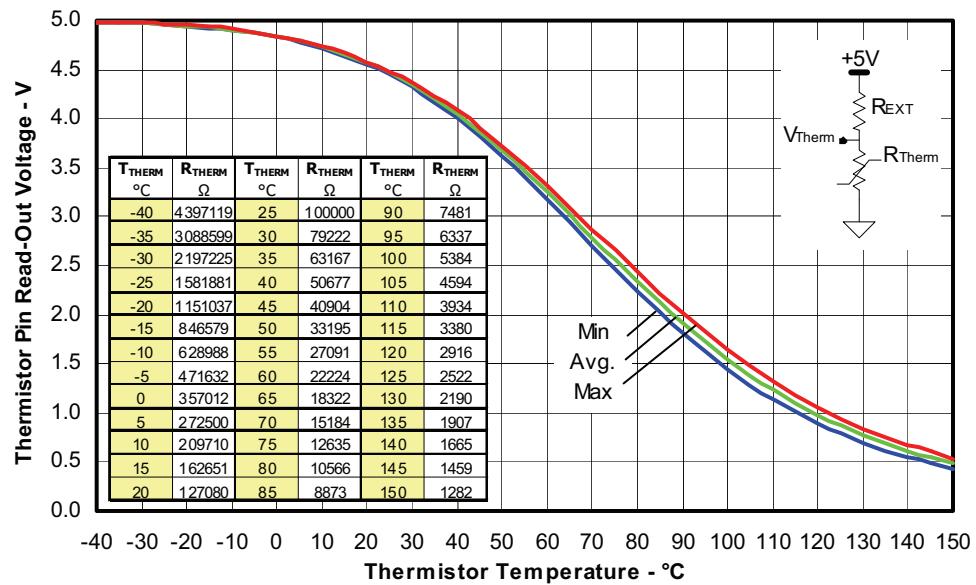


Figure 9. Thermistor Readout vs. Temperature (12Kohm pull-up resistor, 5V) and Normal Thermistor Resistance values vs. Temperature Table.

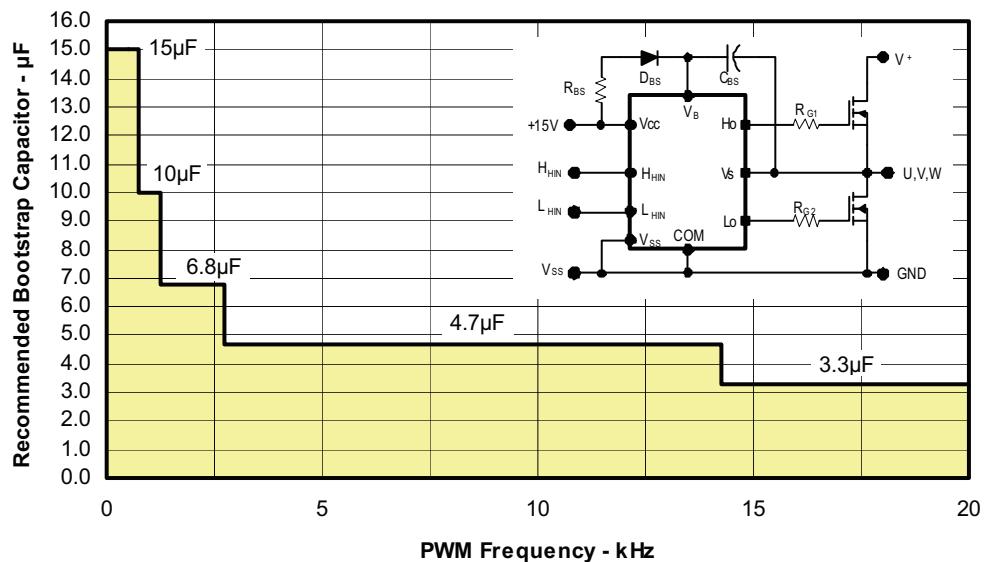


Figure 10. Recommended Bootstrap Capacitor Value vs. Switching Frequency

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Figure 11. Switching Parameter Definitions

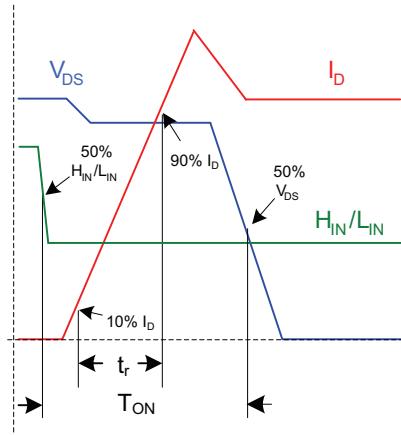


Figure 11a. Input to Output propagation turn-on delay time.

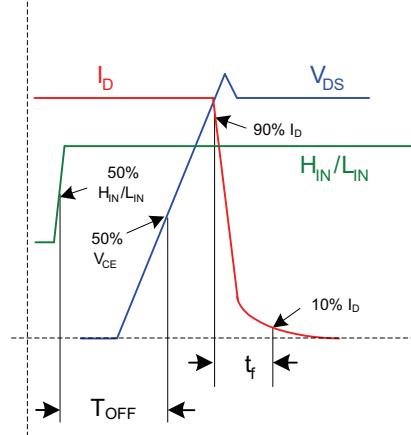


Figure 11b. Input to Output propagation turn-off delay time.

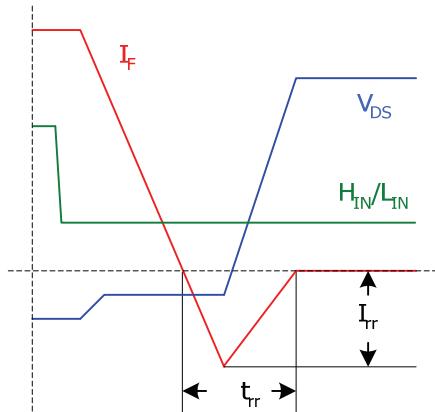


Figure 11c. Diode Reverse Recovery.

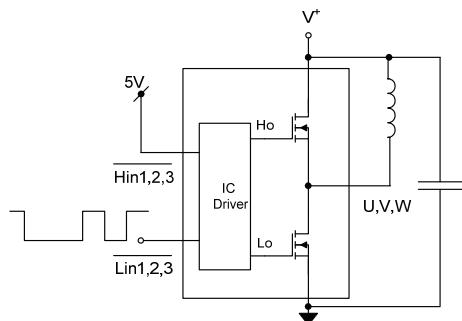


Figure CT1. Switching Loss Circuit

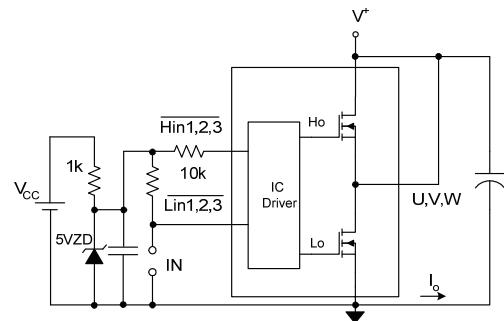
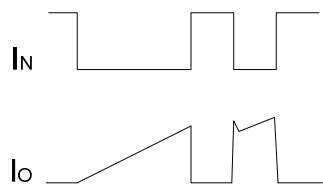


Figure CT2. S.C.SOA Circuit

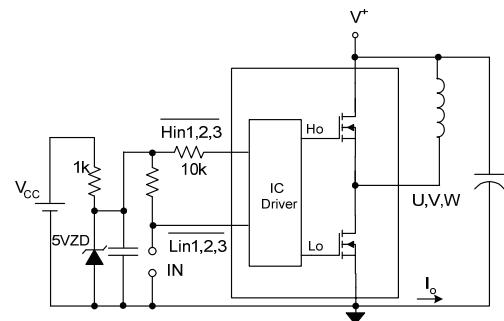
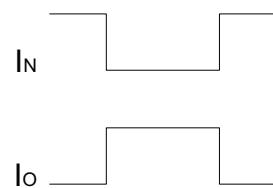
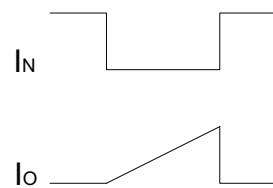


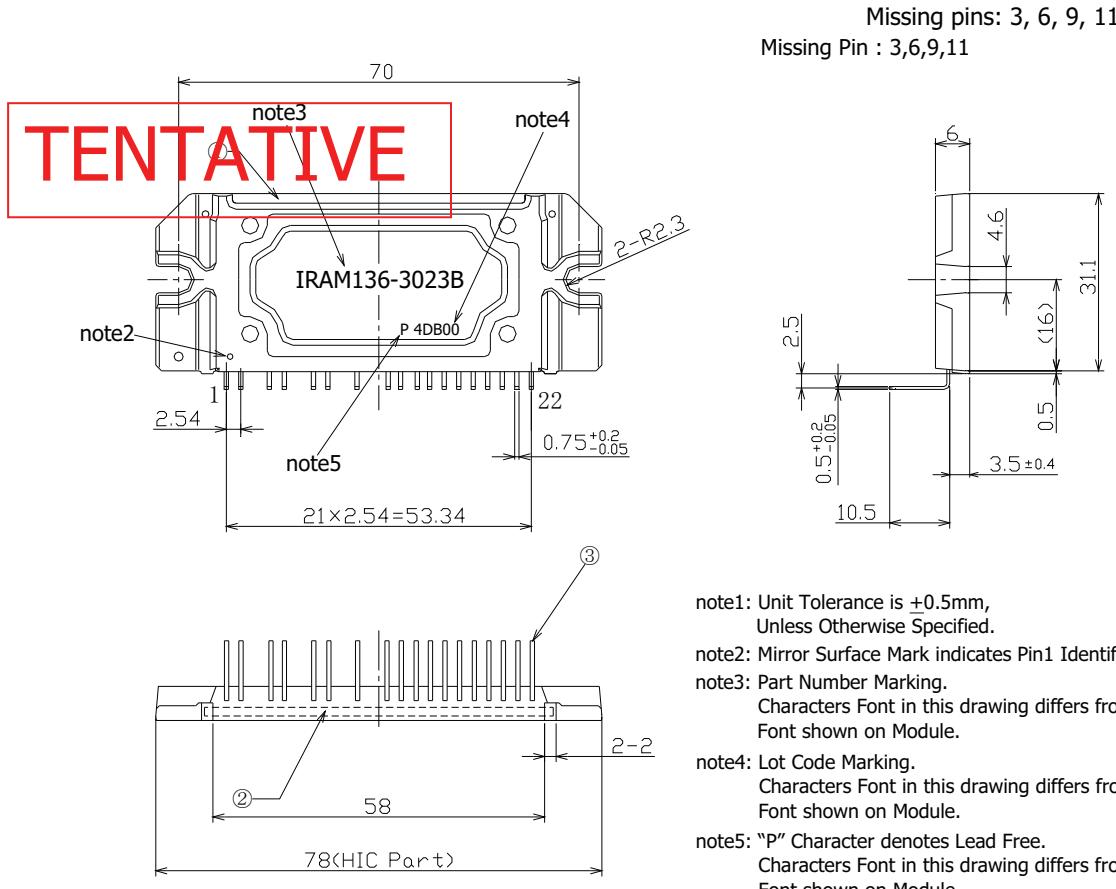
Figure CT3. R.B.SOA Circuit



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Package Outline



For mounting instruction see AN-1049

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Data and Specifications are subject to change without notice
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